

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
-- PATENT APPLICATION --

Applicant: : Aron T. Lunde
Application No.: : 10/053,963
Filed: : January 22, 2002
Title: : A DIE ASSEMBLY AND METHOD FOR FORMING A
DIE ON A WAFER
Examiner : Nguyen, Khiem D.
Group Art Unit : 2823
Confirmation No. : 5214
Attorney Docket No. : 37829.0400

RESPONSE AND AMENDMENT TO OFFICE ACTION

Mail Stop AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Applicant hereby responds to the Office Action dated April 13, 2006 and respectfully requests the Examiner to consider the following amendments and remarks:

Amendments to the Claims are reflected in the listing of claims, which begin on page 2 of this paper.

Remarks/Arguments begin on page 8 of this paper.

Conclusion begins on page 14 of this paper.